



# UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
United States Patent and Trademark Office  
Address: COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, Virginia 22313-1450  
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/809,317	03/24/2004	G. Ramanath	020752-000112US	6500
23308	7590	12/13/2005		
PETERS VERNY JONES & SCHMITT, L.L.P. 425 SHERMAN AVENUE SUITE 230 PALO ALTO, CA 94306			EXAMINER RODGERS, COLLEEN E	
			ART UNIT 2813	PAPER NUMBER

DATE MAILED: 12/13/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

41A

<b>Office Action Summary</b>	<b>Application No.</b>	<b>Applicant(s)</b>	
	10/809,317	RAMANATH ET AL.	
	<b>Examiner</b>	<b>Art Unit</b>	
	Colleen E. Rodgers	2813	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

- 1) ☒ Responsive to communication(s) filed on 24 March 2004.
- 2a) ☐ This action is **FINAL**.                      2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

- 4) ☒ Claim(s) 1-11 and 24-28 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-11 and 24-28 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 24 March 2004 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

**Priority under 35 U.S.C. § 119**

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All    b) ☐ Some \*    c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

**Attachment(s)**

- |  |   |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892)                                   | 4) <input type="checkbox"/> Interview Summary (PTO-413)                     |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)               | Paper No(s)/Mail Date. _____  |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| Paper No(s)/Mail Date <u>3/24/04</u> <u>113165</u>   | 6) <input type="checkbox"/> Other: _____                                    |

## DETAILED ACTION

### *Information Disclosure Statement*

1. The information disclosure statement filed 03 January 2005 fails to comply with 37 CFR 1.98(a)(2), which requires a legible copy of each cited foreign patent document; each non-patent literature publication or that portion which caused it to be listed; and all other information or that portion which caused it to be listed. Yin, H. et al, "Nanostructured iron-nickel thin films synthesized by electroless polyol deposition," *Mater. Phys. Mech.*, 4: 56-61 (2001) was not supplied in either this application or its parents, 09/976,927. All other references have been considered.

### *Claim Objections*

2. Claim 3 is objected to because of the following informalities: in line 2, remove one of the two instances of the word "and" for correct grammar. Appropriate correction is required.

### *Claim Rejections - 35 USC § 102*

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

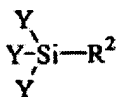
(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

4. Claims 1, 2, 5-11 are rejected under 35 U.S.C. 102(b) as being anticipated by **Calvert et al** (USPN 5,389,496).

Art Unit: 2813

Regarding claim 1, **Calvert et al** discloses a method for forming a diffusion barrier comprising the steps of: preparing a silicon substrate [see col. 5, line 52-col. 6, line 20 and col. 10, lines 49-56]; contacting the silicon substrate with a composition comprising self-assembled monolayer subunits and a solvent [see Example 1, col. 12]; and removing the solvent [Example 33; see also col. 12, lines 52-56], thereby forming the diffusion barrier.

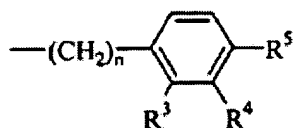
Regarding claim 2, **Calvert et al** discloses the method of claim 1 as described above, wherein the self-assembled monolayer unit is of the structure:



wherein Y is OCH<sub>3</sub> and wherein R<sup>2</sup> is a heteroalkyl group, specifically propylamine [see Example 4 (3-(trimethoxysilyl) propylamine)].

Regarding claim 5, **Calvert et al** discloses the method of claim 1 as described above, wherein the method further comprises the step of heating the silicon substrate and the composition during contact [see col. 12, lines 49-52].

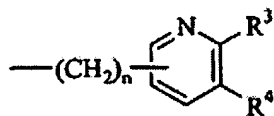
Regarding claim 6, **Calvert et al** discloses the method according to claim 2 as described above, wherein R<sup>2</sup> is an alkyl group of the following structure:



wherein R<sup>3</sup>, R<sup>4</sup> and R<sup>5</sup> are hydrogen, and wherein n is 1 [see Example 19 (4-chloromethylphenyltrimethoxysilane)].

Art Unit: 2813

Regarding claim 7, **Calvert et al** discloses the method according to claim 2 as described above, wherein  $R^2$  is an alkyl group of the following structure:



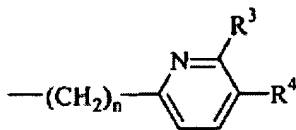
wherein  $R^3$ ,  $R^4$  and  $R^5$  are hydrogen, and wherein  $n$  is 2 [see Examples 1, 2, 11, 19-24, 28, 29 and 31 ( $\beta$ -trimethoxysilylethyl-2-pyridine)].

Regarding claim 8, **Calvert et al** discloses the method of claim 5 as described above, wherein  $Y$  is  $OCH_3$  [see Example 4 (3-(trimethoxysilyl) propylamine)].

Regarding claim 9, **Calvert et al** discloses the method of claim 6 as described above, wherein  $Y$  is  $OCH_3$  [see Example 19 (4-chloromethylphenyltrimethoxysilane)].

Regarding claim 10, **Calvert et al** discloses the method of claim 7 as described above, wherein  $R^3$ ,  $R^4$  and  $R^5$  are hydrogen, and wherein  $n$  is 2 [see Examples 1, 2, 11, 19-24, 28, 29 and 31 ( $\beta$ -trimethoxysilylethyl-2-pyridine)].

Regarding claim 11, **Calvert et al** discloses the method of claim 8 as described above, wherein  $R^2$  is an alkyl group of the following structure:



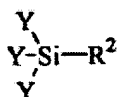
and wherein  $R^3$  and  $R^4$  are hydrogen and  $n$  is 2 [see Example 4 (3-(trimethoxysilyl) propylamine)].

Art Unit: 2813

5. Claims 1, 3, 4 are rejected under 35 U.S.C. 102(b) as being anticipated by **Schnur et al** (USPN 5,079,600).

Regarding claim 1, **Schnur et al** discloses a method for forming a diffusion barrier layer comprising the steps of: preparing the silicon substrate [see col. 11, lines 24-26]; contacting the silicon substrate with a composition comprising self-assembled monolayer subunits and a solvent [see col. 11, lines 31-36]; and removing the solvent [see col. 11, lines 36-39], thereby forming the diffusion barrier.

Regarding claim 3, **Schnur et al** discloses the method of claim 1 as described above, wherein the self-assembled monolayer unit is of the following subunit:



wherein Y is chlorine, and wherein R<sup>2</sup> is a heteroaryl group, specifically pyridine [see Example 28 (trichloro(4-pyridyl)-ethylsilane)].

Regarding claim 4, **Schnur et al** discloses the method of claim 1 as described above, wherein the silicon substrate preparation comprises the formation of a silicon oxide surface [see col. 1, lines 24-26].

### ***Claim Rejections - 35 USC § 103***

6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Art Unit: 2813

7. Claims 24-30 are rejected under 35 U.S.C. 103(a) as being unpatentable over **Schnur et al** (USPN 5,079,600) in view of *ASM Handbook Vol. 5, Surface Engineering*, ASM International: Materials Park, Ohio, 1994, pp. 315-318 and the basic textbook by **Porterfield**, *Inorganic Chemistry: A Unified Approach*, Addison-Wesley: Reading, Massachusetts, 1984, pp. 487-488.

Regarding claim 24, **Schnur et al** discloses a method of forming a device, the method comprising: providing a substrate [see Fig. 1A]; providing a diffusion barrier layer (called “thin film”), wherein the diffusion barrier comprises a self-assembled monolayer [see col. 10, lines 42-47], wherein the self-assembled monolayer is a single layer of molecules [see col. 7, lines 11-15], and wherein the molecules in the self-assembled monolayer have first ends attached to the substrate and second ends projecting upward from the substrate [see Fig. 1A]; and forming a metal layer on the diffusion barrier layer using a vapor deposition process, wherein the metal layer is in direct contact with the second ends of the molecules in the self-assembled monolayer [see col. 9, lines 10-17, wherein a seed layer of Pd/Sn is coated over the self-assembled monolayer; see col. 4, lines 14-17, wherein vapor deposition is given as a known method for fabricating metal paths; and see Fig. 3A for the configuration thereof].

**Schnur et al** does not disclose that the metal layer is copper. The *ASM Handbook* teaches that copper may be used as a catalyst for electroless plating of copper (pp. 315-318, especially p. 318, sections entitled “Catalyzation” and “Copper catalyst”). **Porterfield** ensures that copper forms metal complexes with pyridine groups, such as the pyridine group used in **Schnur et al** as the polar end-group of each molecule in the self-assembled monolayer barrier layer. It would have been obvious to one of ordinary skill in the art at the time of invention to use copper as the metal catalyst in **Schnur et al** as taught in the *ASM Handbook* because **Schnur et al** is not limited to Pd/Sn catalysts, and because copper is a known catalyst for electroless copper plating, as used in **Schnur et**

Art Unit: 2813

al, as taught by the *ASM Handbook*. In this regard, it has been held that the selection of a known material based upon its suitability for an intended purpose is obvious. Moreover, the *ASM Handbook* teaches that copper-based catalysts are less expensive than palladium-based catalysts, thereby providing additional motivation to use copper. Finally, **Schnur et al** only requires that the catalyst bond to the polar end groups of the molecules (i.e., the pyridyl end groups of Example 28 in **Schnur et al**). **Porterfield** ensures that such bonding occurs, such that one of ordinary skill has a reasonable expectation of success for using copper instead of Pd/Sn as the catalyst in **Schnur et al**.

Regarding claim 25, it is held absent evidence to the contrary that the diffusion barrier of **Schnur et al** is capable of preventing diffusion of metal atoms from the metal layer into the substrate when the semiconductor device is exposed to an electric field of 2 MV/cm at about 200° for about 30 minutes. Basis for this reasoning is that Applicant is using the exact same self-assembling monolayer as is **Schnur et al** to form the barrier layer. **Schnur et al** also points out in Example 24 that copper diffusion does not occur even under the stress of an electric field. See *In re Swinehart*, 169 USPQ 226, 229 (CCPA 1971) (where the Patent Office has reason to believe that a functional limitation asserted to be critical for establishing novelty in the claimed subject matter may, in fact, be an inherent characteristic of the prior art, it possesses the authority to require the applicant to prove that subject matter shown to be in the prior art does not possess the characteristics relied on) and *In re Fitzgerald*, 205 USPQ 594 (CCPA 1980) (the burden of proof can be shifted to the applicant to show that subject matter of the prior art does not possess the characteristic relied on whether the rejection is based on inherency under 35 USC 102 or obviousness under 35 USC 103). Note that as long as there is evidence of record establishing inherency, failure of those skilled in the art to contemporaneously recognize an inherent property, function or ingredient of a prior art reference does not preclude a finding of anticipation. See *Atlas*



Art Unit: 2813

*Powder Co. v. IRECO, Inc.*, 190 F.3d 1342, 1349, 51 USPQ2d 1943, 1948 (Fed. Cir. 1999) (Two prior art references disclosed blasting compositions containing water-in-oil emulsions with identical ingredients to those claimed, in overlapping ranges with the claimed composition. The only element of the claims arguably not present in the prior art compositions was “sufficient aeration ... entrapped to enhance sensitivity to a substantial degree.” The Federal Circuit found that the emulsions described in both references would inevitably and inherently have “sufficient aeration” to sensitize the compound in the claimed ranges based on the evidence of record (including test data and expert testimony). This finding of inherency was not defeated by the fact that one of the references taught away from air entrapment or purposeful aeration.). See also *In re King*, 801 F.2d 1324, 1327, 231 USPQ 136, 139 (Fed. Cir. 1986); *Titanium Metals Corp. v. Banner*, 778 F.2d 775, 782, 227 USPQ 773, 778 (Fed. Cir. 1985).

Regarding claim 26, Example 24 in **Schnur et al** states that the substrate is a silicon wafer with silicon oxide formed thereon.

Regarding claim 27, the first ends of the molecules in **Schnur et al** is a pyridyl group, which is an aromatic group.

Regarding claim 28, **Schnur et al** teaches that sputtering is a known form of vapor deposition for fabricating metal paths [see col. 4, lines 14-17].

### ***Conclusion***

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Colleen E. Rodgers whose telephone number is (571) 272-8603. The examiner can normally be reached on Monday through Friday, 7:30 AM to 4:00 PM.

Art Unit: 2813

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead can be reached on (571) 272-1702. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

CER

  
GEORGE ECKERT  
PRIMARY EXAMINER